Important Notices

Thank you for your continued patronage of Toshiba microcontrollers.

This page gives you important information on using Toshiba microcontrollers. Please be sure to check each item for proper use of our products.



TOSHIBA Microcontrollers 870 Family

(TMP87C409BN) (TMP87C409BM) (TMP87C809BN) (TMP87C809BM) (TMP87P809)

Datasheet Modifications: I2C Bus Mode Control

The following problem is included in the explanation of the I²C bus function of this data sheet. It will guide the correction as follows. Please read it for the explanation of this data sheet as follows.

Section: "I2C Bus Mode Control"

- In the explanation of the Serial Bus Interface Control Register 1
 - 1. Delete the setting examples where the serial clock frequency exceeds 100 kHz
 - 2. Add the following note.

SCK	Serial clock selection	(pin)	Write- only
-----	------------------------	--------	----------------

Note: This I²C bus circuit does not support the Fast mode. It supports the Standard mode only. Although the I²C bus circuit itself allows the setting of a baud rate over 100 kbps, the compliance with the I²C specification is not guaranteed in that case.

- In "(3) Serial clock"
 - 1. Add the following sentence about the communication baud rate.
 - a. Clock source

The SCK (bits 2 to 0 in the SBICR1) is used to select a maximum transfer frequency outputed on the SCL-pin in the master mode. Set a communication baud rate that meets the I²C bus specification, such as the shortest pulse width of t_Low, based on the equations shown below.

In both master mode and slave mode, a pulse width of at least 4 machine cycles is require for both "H" and "L" levels.

$$t_{LOW} = 2^{n}/f_{c}$$

$$t_{HIGH} = 2^{n}/f_{c} + 8/f_{c}$$

$$f_{scl} = 1/(t_{LOW} + t_{HIGH})$$

2008-02-08

Document Change Notification

The purpose of this notification is to inform customers about the launch of the Pb free version of the device. The introduction of a Pb-free replacement affects the datasheet. Please understand that this notification is intended as a temporary substitute for a revision of the datasheet.

Changes to the datasheet may include the following, though not all of them may apply to this particular device.

1. Part number

Example: TMPxxxxxxFG TMPxxxxxxFG

All references to the previous part number were left unchanged in body text. The new part number is indicated on the prelims pages (cover page and this notification).

2. Package code and package dimensions

Example: LQFP100-P-1414-0.50C

LQFP100-P-1414-0.50F

All references to the previous package code and package dimensions were left unchanged in body text. The new ones are indicated on the prelims pages.

3. Addition of notes on lead solderability

Now that the device is Pb free, notes on lead solderability have been added.

Ι

4. RESTRICTIONS ON PRODUCT USE

The previous (obsolete) provision might be left unchanged on page 1 of body text. A new replacement is included on the next page.

5. Publication date of the datasheet

The publication date at the lower right corner of the prelims pages applies to the new device.

2008-03-06

1. Part number

Package code and dimensions

Previous Part Number (in Body Text)	Previous Package Code (in Body Text)	New Part Number	New Package Code	ОТР
TMP87P809N	P-SDIP28-400-1.78	TMP87P809NG	SDIP28-P-400-1.78	_
TMP87P809M	P-SOP28-450-1.27	TMP87P809MG	SOP28-P-450-1.27B)	_

^{*:} For the dimensions of the new package, see the attached Package Dimensions diagram.

Addition of notes on lead solderability

The following solderability test is conducted on the new device.

Lead solderability of Pb-free devices (with the G suffix)

Test	Test Conditions	Remark
Solderability	(1) Use of Lead (Pb) -solder bath temperature = 230°C -dipping time = 5 seconds -the number of times = once -use of R-type flux (2) Use of Lead (Pb)-Free -solder bath temperature = 245°C -dipping time = 5 seconds -the number of times = once -use of R-type flux	Leads with over 95% solder coverage till lead forming are acceptable.

4. RESTRICTIONS ON PRODUCT USE

The following replaces the "RESTRICTIONS ON PRODUCT USE" on page 1 of body text.

RESTRICTIONS ON PRODUCT USE

20070701-EN

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.

In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.

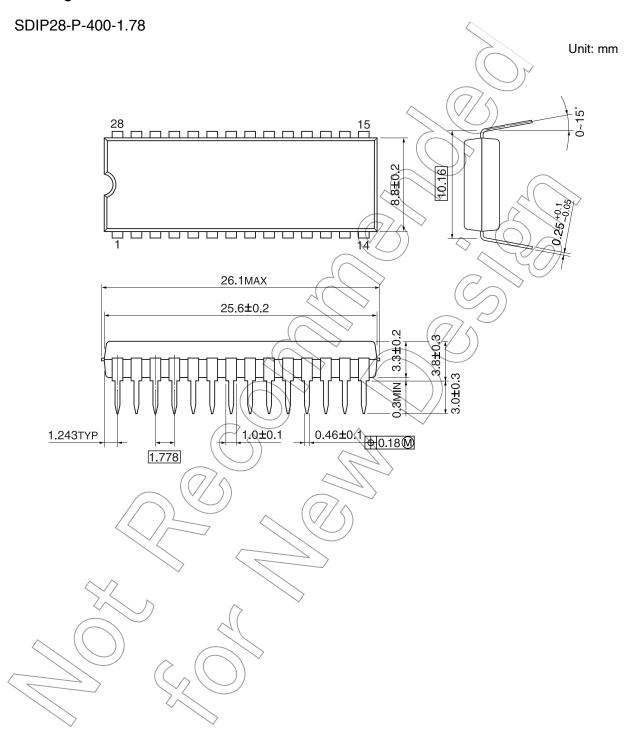
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the icustomer's own risk.
- The products described in this document shall not be used or embedded to any downstream products of which
 manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility
 is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its
 use. No license is granted by implication or otherwise under any patents or other rights of TOSHIBA or the third
 parties.
- Please contact your sales representative for product-by-product details in this document regarding RoHS
 compatibility. Please use these products in this document in compliance with all applicable laws and regulations that
 regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses occurring
 as a result of noncompliance with applicable laws and regulations.
- For a discussion of how the reliability of microcontrollers can be predicted, please refer to Section 1.3 of the chapter entitled Quality and Reliability Assurance/Handling Precautions.

5. Publication date of the datasheet

The publication date of this datasheet is printed at the lower right corner of this notification.

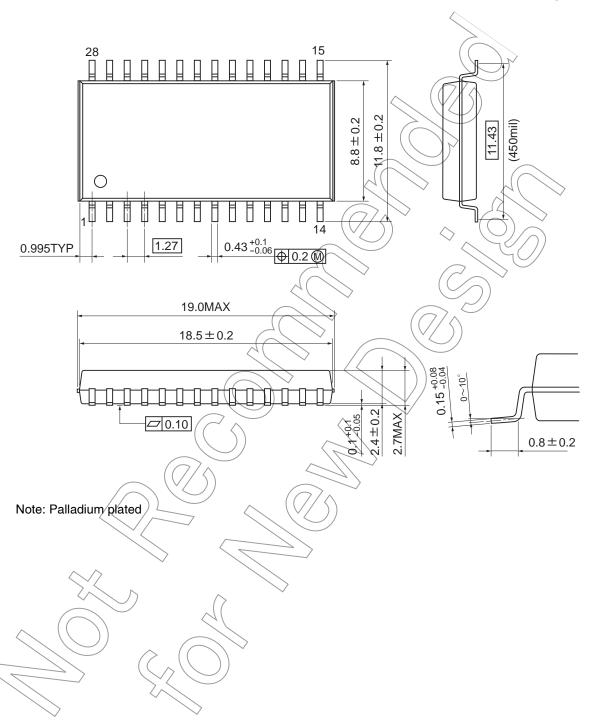
(Annex)

Package Dimensions



SOP28-P-450-1.27B

Unit: mm



CMOS 8-bit Microcontroller

TMP87P809N/M

The TMP87P809 is a high-speed, high-performance 8-bit single chip microcomputer, which has 64-Kbits One-Time PROM. The TMP87P809 is pin compatible with the TMP87C409B/809B. The operations possible with the TMP87C409B/809B can be performed by writing programs to PROM. The TMP87P809 can write and verify in the same way as the TC57256AD using an adapter socket and a general purpose PROM programmer.

	Poduct No.	ROM	RAM	Package Adapter socket	
	TMP87P809N			P-SDIP28-400 1.78 BM11122	
	TMP87P809M	8 Kbytes	256 bytes	P-SOP28-450-1-27 BM11116	
Pin Assignı	ments (Top Vi	ew)		P;SDIP28-400-1.78	7
				(7) A 173DIF 20-400-11.70	ı
SOP28/SDIP28	3				ı
	DIDENCHIT - H	, ,	28 □←VDD (VÁI	REET VICC	ı
	DIDS/XOUT ← □		27 □ ← RESET		ı
	CLOCK/XIN >		26 - P17/A7/D		ı
	VPP/TEST→□		25 P16/A14/		ı
	′ (AIN0) P60 <> □ ′ (AIN1) P61 <> □		24 P15/A13/	·	ı
	(AIN1) P61 → □ (AIN2) P62 ↔ □		23. P14/A12/		ı
	(AIN2) P62 ← ☐ (AIN3) P63 ← ☐		22 2 P13 (DVO	/ D-SAD29-150-1-27	ı
D 1/A 1/A9/	(AIN4) P64 <> □		21 0 P12 (TC1)		ı
	` '		20 P11 (INT1		ı
			. ' -) /		ı
(AINI7/)	` ′	/ 7		A A A A A A A A A A A A A A A A A A A	ı
•	· .		\	-1 SMILLS.	ı
•	·		/		ı
	1	////	/ \		ı
SIND		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		^	L
	//)		$\langle \langle \langle \rangle \rangle \rangle$	$\langle \rangle$	
(TC3/INT:	(AIN5) P65 ↔ □ (AIN6) P66 ↔ □ VAREF) P67 ↔ □ 3/CLZ0) P50 ↔ □ (VASS) VSS → □	10 11 12 13	20 P11 (INT1 19 P10 (INT0 18 P43 (STOR 17 P42 (SDA) 16 P41 (SCL) 15 P40 (SCK)	O) OP/INTS) A/SO) Th/IP87P809M	

For a discussion of how the reliability of microcontrollers can be predicted, please refer to Section 1.3 of the chapter entitled Quality and Reliability Assurance / Handling Precautions.

- Quality and Reliability Assurance / Handling Precautions.

 TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..

 The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.

 The information contained herein is subject to change without notice.

Pin Function

The TMP87P809 has two modes: MCU and PROM.

(1) MCU mode
In this mode, the TMP87P809 is pin compatible with the TMP87C409B/809B (fix the TEST pin at "L" level).

(2) PROM mode

Pin Name (PROM mode)	Input / Output	Functions	Pin name (MCU mode)
A14 to A8	Input	Program memory address input	P17 to P12, P63, P62
A7 to A0		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	P17/to P12, P63, P62
D7 to D0	I/O	Program memory data input/output	P17 to P12, P63, P62
CE	Input	Chip enable signal input	P61
ŌĒ	input	Output enable signal input	P60
VPP		+ 12.5 V / 5 V (Program supply voltage)	TEST
vcc	Power supply	+5V	VDD
GND		ov (V)	vss
P11 to P10			
P43 to P40	I/O		
P51 to P50		RROM mode setting pins. Be fixed at "L" level.	
P67 to P64			
RESET	Input		
XIN	Input	Inputs a clock externally (CLOCK)	XIN
хоит	Input	PROM mode control signal (DIDS) input	хоит

Operational Description

The configuration and function of the TMP87P809 are the same as those of the TMP87C409B/809B, except in that a one-time PROM is used instead of an on-chip mask ROM.

1. Operating Mode

The TMP87P809 has two modes: MCU and PROM.

1.1 MCU Mode

The MCU mode is activated by fixing the TEST/VPP pin at "L" level.

In the MCU mode, operation is the same as with the TMP87C409B/809B (TEST/VPP pin cannot be used open because it has no built in pull-down resistance.)

1.1.1 Program memory

The TMP87P809 has a 8 Kbyte (addresses E000 to FFFF_H in the MCO mode, addresses 6000 to 7FFF_H in the PROM mode) one-time PROM.

To use the TMP87P809 as the system evaluation for the TMP87C409B/809B, the program should be written to the program memory area as shown in Figure 1-1.

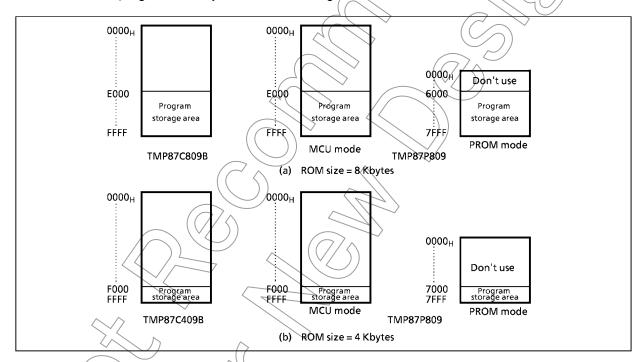


figure 1-1. Program memory area

Note: Either write the data FFH to the unused area or set the general-purpose PROM programmer to access only the program storage area

1.1.2 Data memory

The TMP87P809 has an 256 bytes data memory (static RAM).

1.1.3 Input / Output circuits

(1) Control pins

The control pins of the TMP87P809 are the same as those of the TMP87C409B/809B except that the TEST pin has no built-in pull-down resistance.

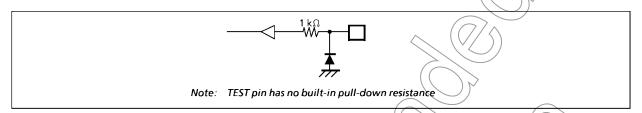


Figure 1-2. TEST Pin

(2) I/O port

The I/O circuits of TMP87P809 ports are the same as the TMP87C409B/809B.

1.2 PROM Mode

The PROM mode is used to write and verify programs with a general-purpose PROM programmer.

Note: Please set the high-speed programming mode according to each manual of PROM programmer.

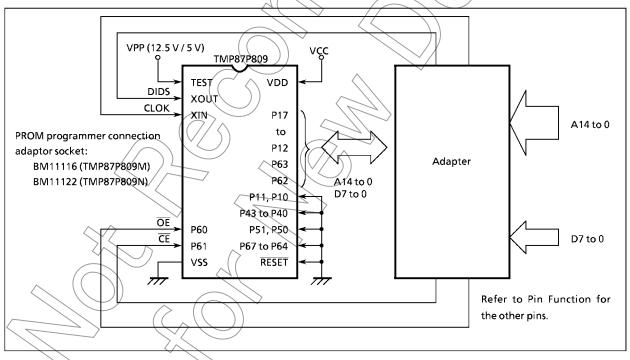


Figure 1-3. Setting for PROM mode

1.2.1 Programming flowchart (High-speed Programming Mode-I)

The high-speed programming mode is achieved by applying the program voltage (\pm 12.5 V) to the Vpp pin when Vcc = 6 V. After the address and input data are stable, the data is programmed by applying a single 1ms program pulse to the \overline{CE} input. The programmed data is verified. If incorrect, another 1ms program pulse is applied and then the programmed data is verified. This process should be repeated (up to 25 times) until the program operates correctly. Programming for one address is ended by applying additional program pulse with width 3 times that needed for initial programming (number of programmed times \times 1 ms). After that, change the address and input data, and program as before. When programming has been completed, the data in all addresses should be verified with Vcc = Vpp = 5 V

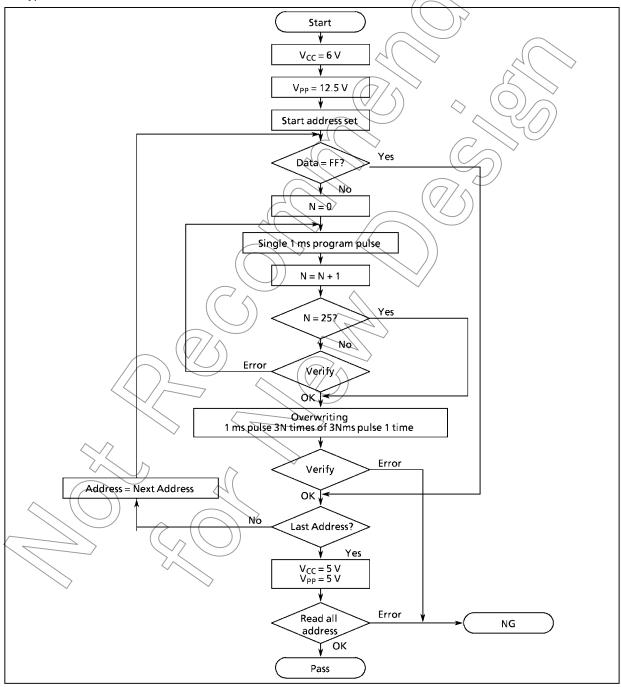


Figure 1-4. Flowchart of high-speed programming mode - $\,\mathrm{I}$

1.2.2 Programming flowchart (High-speed Programming Mode-II)

The high-speed programming mode is achieved by applying the program voltage (\pm 12.75 V) to the Vpp pin when Vcc = 6.25 V. After the address and input data are stable, the data is programmed by applying a single 0.1ms program pulse to the $\overline{\text{CE}}$ input. The programmed data is verified. If incorrect, another 0.1ms program pulse is applied and then the programmed data is verified. This process should be repeated (up to 25 times) until the program operates correctly. After that, change the address and input data, and program as before. When programming has been completed, the data in all addresses should be verified with Vcc = Vpp = 5 V.

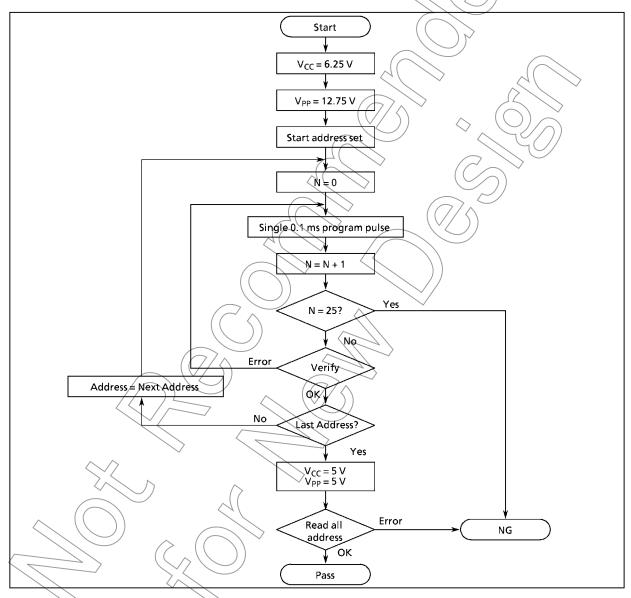


Figure 1-5. Flowchart of high-speed programming mode - II

1.2.3 Writing method for general-purpose PROM program

(1) Adapters

BM11116: TMP87P809M BM11122: TMP87P809N

(2) Adapter setting Switch (SW1) is set to side N.

(3) PROM programmer specifying

i) PROM type is specified to TC57256AD.

Writing voltage: 12.5 V (high-speed program I mode) 12.75 V (high-speed program I mode)

ii) Data transfer (copy) (note 1)

In TMP87P809, EPROM is within the addresses 6000 to 7FFF_H. Data is required to be transferred (copied) to the addresses where it is possible to write. The program area in MCU mode and PROM mode is referred to "Program memory area" in Figure 1-1.

Ex. In the block transfer (copy) mode, executed as below.

ROM capacity of 4KB: transferred addresses F000 to FFFF_H to addresses 7000 to 7FFF_H

ROM capacity of 8KB: transferred addresses F000 to FFFF_H to addresses 6000 to 7FFF_H

iii) Writing address is specified. (note 1)

Start address: 7000H (ROM 8 KB: 6000H)

End address: 7FFF_H

(4) Writing

Writing/Verifying is required to be executed in accordance with PROM programmer operating procedure.

- Note 1: The specifying method is referred to the PROM programmer description. The data in addresses 0000 to 5FFF_H must be specified to FF_H.
- Note 2: When MCU is set to an adapter or the adapter is set to PROM programmer, a position of pin 1 must be adjusted. If the setting is reversed, MCU, the adapter and PROM program is damaged.
- Note 3: TMP87P809 does not support the electric signature mode (hereinafter referred to as "signature"). If the signature is used in PROM program, a device is damaged due to applying 12 V \pm 0.5 V to the address pin 9 (A9). The signature must not be used.

Electrical Characteristics

Absolute Maximum Ratings (V_{SS} = 0 V)

Parameter		Symbol	Condition	Ratings	Unit
Supply Voltage		V_{DD}		-0.3 to 6.5	V
Program Voltage		V_{PP}	TEST/V _{PP} pin	0.3 to 13.0	V
Input Voltage		V _{IN}		0.3 to V _{DD} + 0.3	V
O. da. d) (ald a		V _{OUT1}	Ports P1, P5, P6, XOUT	-0.3 to $V_{DD} + 0.3$	
Output Voltage		V _{OUT2}	Port P4	- 0.3 to 5.5	V
Outro de Compani	IOL	l _{OUT1}	Ports P1, P6	3.2	
Output Current		I _{OUT2}	Ports P4, P5	30	mA
(Per 1 pin)	ЮН	I _{OUT3}	Ports P1, P5, P6	-1.8	
Outrast Comment	IOL	Σ l _{OUT1}	Ports P1, P6	30	
Output Current		Σ I _{OUT2}	Ports P4, P5	((80))	mA
(Total)	ЮН	Σ l _{OUT3}	Ports P1, P5, P6	30/	
Daniel Discharting D	70001	PD	SD	IP 300	>0/
Power Dissipation [Topr = 70°C]			SC	OP 180	mW
Soldering Temperature (time)		Tsld		260 (10 s)	°C
Storage Temperature		Tstg		55 to 125	°C
Operating Tempera	ture	Topr		- 30 to 70	°C

Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

Recommended Operating Conditions

 $(V_{SS} = 0 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Pins	7	Sonditions	Min	Max	Unit		
		(// 5)	£ 9.0411=	NORMAL mode	4.5				
			fc = 8 MHz	IDLE mode	4.5				
Supply Voltage	VpD		fc≦	NORMAL mode	2.2	5.5	v		
			4.2 MHz	IDLE mode	2.2	.			
				STOP mode	2.0				
	V _{IH1}	V _{IH1} Except hysteresis input V _{IH2} Hysteresis input		V _{DD} ≧ 4.5 V		rept hysteresis input V _{DD} × 0.70			
Input High Voltage	y _{IH2}					V _{DD}	V		
	V _{IH3}	4	٧	′ _{DD} < 4.5 V	$V_{DD} \times 0.90$				
	V _{IL1}	Except hysteresis input	,	. > 4 5 7		$V_{DD} \times 0.30$			
Input Low Voltage	V _{(L2}	Hysteresis in put	$V_{DD} \ge 4.5 V$		0	$V_{DD} \times 0.25$	v		
	V _{IL3}		٧	′ _{DD} < 4.5 V		V _{DD} × 0.10			
Clark Face		VINIVOLIT	VDD	e 4.5 to 5.5 V	1.0	8.0	NALL-		
Clock Frequency	fc XIN, XOUT		V _{DD} = 2.2 V to 5.5 V		1.0	4.2	MHz		

Note1: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

Note2: Clock frequency fc: Supply voltage range is specified in NORMAL mode and IDLE mode.

DC Characteristics

 $(V_{SS} = 0 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Pins	Conditions	Min	Тур.	Max	Unit
Hysteresis Voltage	V_{HS}	Hysteresis input		(-)	0,9	-	V
	I _{IN1}	TEST	V _{DD} = 5.5 V))`		
Input Current	I _{IN2}	Tri-state ports	V _{IN} = 5.5 V / 0 V	> -	_	± 2	μA
	I _{IN3}	RESET, STOP		()			
Input Resistance	R _{IN2}	RESET	7//6	100	220	450	kΩ
Output Leakage Current	I _{LO}	Tri-state ports	$V_{DD} = 5.5 \text{ V}, V_{OUT} = 5.5 \text{ V} \times 0 \text{ V}$	- 2	-	2	μΑ
Output High Voltage	V _{OH2}	Tri-state ports	$V_{DD} = 4.5 \text{ V}, V_{OH} = -0.7 \text{ mA}$	4.1	7	-	v
Output Low Voltage	V _{OL1}	Except XOUT, P4 and P5	$V_{DD} = 4.5 \text{ V}, V_{QL} = 1.6 \text{ mA}$	-	A (0.4	\ \ \
Output Low current	I _{OL3}	P4, P5	$V_{DD} = 4.5 \text{ V}, V_{OL} = 1.0 \text{ V}$	- ^	20		mA
Supply Current in			V _{DD} = 5.5V		8	14	
NORMAL modes			fc = 8 (V/Hz)))	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	mA
Supply Current in			$V_{\rm JN} = 5.3 \text{ V} / 0.2 \text{ V}$		$\mathbb{C}/$	6	'''A
IDLE modes				7	\setminus		
Supply Current in	1	$\langle \langle \langle \rangle \rangle \rangle$	$V_{DD} = 3.0 \text{ V}$		2.5	3.5	
NORAML mode	DD		fc = 4.2 MHz		2.5	3.3	mA
Supply Current in			$V_{1N} = 2.8 \text{ V} / 0.2 \text{ V}$		1.5	2.0	'''^
IDLE mode]		\Diamond $(\lor/)$		1.5	2.0	
Supply Current in		4()	V _{DD} = 5.5 V		0.5	10	μΑ
STOP mode			V _{IN} = 5.3/V / 0.2 V		0.5	10	μ^

Note 1: Typical values show those at Topr = 25° C, $V_{DD} = 5$ V.

Note 2: Input Current IIN1, IIN3,: The current through resistor is not included, when the input resistor (pull-up or pull-down) is contained.

AD Conversion Characteristics

 $(V_{gg} = 0V) V_{DD} = 2.2 \text{ to 5.5V. Topr} = -30 \text{ to } 70^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
Analog Reference Voltage	V _{AREF}		2.2	_	V _{DD}	V
Allalog Reference Voltage	V _{ASS}		V _S	s		
Analog Input Voltage range	V _{AIN} /	>	V _{ASS}	_	V _{AREF}	V
Analog Reference Current	IREE	$V_{AREF} = 5.5 V, V_{ASS} (V_{SS}) = 0.0 V$	-	0.5	1.0	mA
Nonlinearity Error		V _{DD} = 5.0 V V _{AREF} = 5.000 V V _{ASS} (V _{SS}) = 0.000 V	_	_	± 2	
Zero Point Error			_	_	± 2	
Full Scale Error		or V _{DD} = 2.2 V V _{AREF} = 2.200 V	_	_	± 2	LSB
Total Error		$V_{ASS}(V_{SS}) = 0.000 \text{ V}$		-	± 4	

Note: Quantizing error is not contained in those errors.

Oscillation Stop Detector Characteristics

 $(V_{SS} = 0 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	SYMBOL	Conditions	Min	Тур.	Max	Unit
Detection time	T	VDD = 2.2 V to 5.5V (fc = 2 MHz to 4.2 MHz)	2	20	400	
Detection time	CLZ	VDD = 4.5 V to 5.5 (fc = 8 MHz)	2	2)	/ 400	μS

AC Characteristics

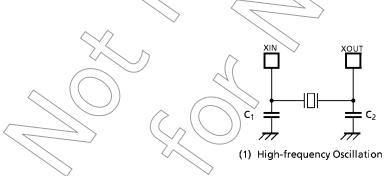
 $(V_{SS} = 0 \text{ V}, V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Conditions	Min	Typ. Max	Unit
Marking Code Time	4.00	In NORMAL mode	0.5	5	
Machine Cycle Time	tcy	In IDLE mode	0.5	4	μS
High Level Clock Pulse Width	t _{WCH}	For external clock operation		59	
Low Level Clock Pulse Width	t _{WCL}	fc = 8 MHz	50	~	ns

Recommended Oscillating Conditions

 $(V_{SS} = 0 \text{ V}, V_{DD} = 2.2 \text{ to } 5.5 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Oseillation				Recommended Constant		
Parameter	Oscillator	Frequency Recommended Osci		ended Oscillator	C ₁	C ₂	
		8 MHz	MURATA	CST8.00MTW	_	_	
High-frequency	(7/1)	(4.5 V to 5.5 V)	MURATA	CSA8.00MTZ	30 pF	30 pF	
Oscillation	Ceramic Resonator	4 MHz	MURATA	CST4.00MGWU	_	_	
<		(2.2 V to 5.5 V)	MURATA	CSA4.00MGU	30 pF	30 pF	



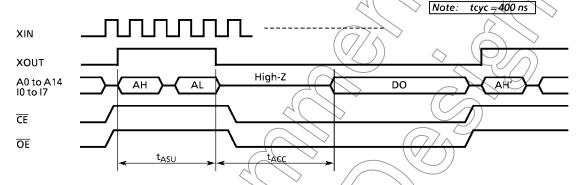
- Note 1: When used in high electric field such as a picture tube, the package is recommended to be electrically shielded to maintain a regular operation.
- Note 2: The product numbers and specifications of the resonators by Murata Manufacturing Co., Ltd. are subject to change. For up-to-date information, please refer to the following

 URL;http://www.murata.com/

(1) READ OPERATION ($T_{opr} = 0 \text{ to } 70^{\circ}\text{C}$)

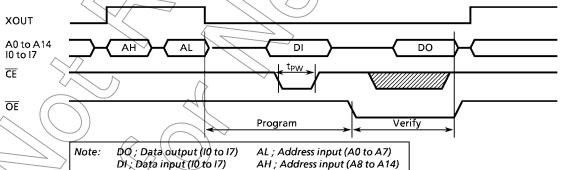
DC Characteristics, AC Characteristics (V_{SS} = 0 V)

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
Input High Voltage	V _{IH4}		V _{CC} × 0.67		V _{CC}	V
Input Low Voltage	V_{IL4}		0 <	((//- {)	$V_{CC} \times 0.3$	V
Supply Voltage	V _{CC}		4.75	5.00	5.25	.,
Program Supply Voltage	V_{PP}		V _{CC} - 0.6	Усс	V _{CC+0.6}	V
Address Set-up Time	t _{ASU}		400	U	1	ns
Address Access Time	t _{ACC}	$V_{CC} = 5.0 \pm 0.25 \text{ V}$		5tcyc	(=)	ns



(2) Program Operation (High speed write mode I) (Topr = 25 \pm 5°C)

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
Input High Voltage	V _{IH} 4		$V_{CC} \times 0.7$	-	V _{CC}	٧
Input Low Voltage	V _{IL4}		0	1	$V_{CC} \times 0.12$	<
Supply Voltage	Vec		→ 5.75	6.0	6.25	V
Program Supply Voltage	(V _{PP})		12.0	12.5	13.0	>
Initial Program Pulse Width	t _{PW}	$V_{CC} = 6.0 \text{ V} \pm 0.25 \text{ V},$ $V_{PP} = 12.5 \text{ V} \pm 0.25 \text{ V}$	0.95	1.0	1.05	ms



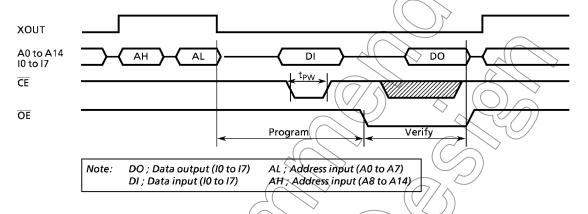
Note1: When V_{cc} power supply is turned on or after, V_{pp} must be increased. When V_{cc} power supply is turned off or before, V_{pp} must be decreased.

Note2: The device must not be set to the EPROM programmer or picked up from it under applying the program voltage (12.5 V \pm 0.5 V) to the V_{pp} pin as the device is damaged.

Note3: Be sure to execute the recommended programing mode with the recommended programing adaptor. If a mode or an adaptor except the above, the misoperation sometimes occurs.

(3) Program Operation (High speed write mode -II) (Topr = $25 \pm 5^{\circ}$ C)

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
Input High Voltage	V _{IH4}		$V_{CC} \times 0.7$	(V _{CC}	٧
Input Low Voltage	V_{IL4}		0	+	$V_{CC} \times 0.12$	٧
Supply Voltage	V _{CC}		6.00	6.25	6.50	٧
Program Supply Voltage	V_{PP}		12.50	(1/2/15\	13.0	٧
Initial Program Pulse Width	t _{PW}	$V_{CC} = 6.25 \text{ V} \pm 0.25 \text{ V},$ $V_{PP} = 12.75 \text{ V} \pm 0.25 \text{ V}$	0.095	0.1	0.105	ms



Note1: When V_{cc} power supply is turned on or after, V_{pp} must be increased.

When V_{cc} power supply is turned off or before, V_{pp} must be decreased.

Note2: The device must not be set to the EPROM programmer or picked up from it under applying the program voltage (12.5 V ± 0.5 V) to the V_{pp} pin as the device is damaged.

Note3: Be sure to execute the recommended programing mode with the recommended programing adaptor. If a mode or an adaptor except the above, the misoperation sometimes occurs.

